Heat sink compound is not required. The requirement for SERVOPACK installation regarding temperature is that the surrounding temperature must not exceed the SERVOPACK specification

As mentioned in the Safety Precautions for SGDV Servo Amplifier manual [TOBPC71080010](https://www.yaskawa.com/links?type=documents&docnum=TOBPC71080010&name=), "Design the control panel size, unit layout, and cooling method so that the surrounding air temperature of the SERVOPACK does not exceed 55°C." (Typically 55 degrees C, refer to the product catalog for specific details).

Using heat sink compound can help lower the amount of heat around the amplifiers, but sufficient means of cooling can also (such as fans).

If using heat sink compound, consider using electrically conductive heat sink compound if installing the SERVOPACK on an electrically conductive surface (unpainted) to help with grounding.